

FEATURES

General

- Incorporates HDMI v.1.4a features
- 3D video support
- Extended colorimetry
- 165 MHz supports all video formats up to 1080p and UXGA
- Supports gamut metadata packet transmission
- Integrated CEC buffer/controller
- Compatible with DVI v.1.0 and HDCP v.1.3
- Video/audio inputs accept logic levels from 1.8 V to 3.3 V

Digital video

- 3D video ready
- Programmable 2-way color space converter
- Supports RGB, YCbCr, and DDR
- Supports ITU656-based embedded syncs
- Automatic input video format timing detection (CEA-861-E)

Digital audio

- Supports standard SPDIF for stereo LPCM or compressed audio up to 192 kHz
- High bit-rate audio (HBR)
- 8-channel uncompressed LPCM I²S audio up to 192 kHz

Special features for easy system design

- On-chip MPU with I²C master to perform HDCP operations and EDID reading operations
- 5 V tolerant I²C and HPD I/Os, no extra device needed
- No audio master clock needed for supporting SPDIF and I²S
- On-chip MPU reports HDMI events through interrupts and registers
- Qualified for automotive applications

APPLICATIONS

Automotive infotainment

- Gaming consoles
- PCs
- DVD players and recorders
- Digital set-top boxes
- A/V receivers

FUNCTIONAL BLOCK DIAGRAM

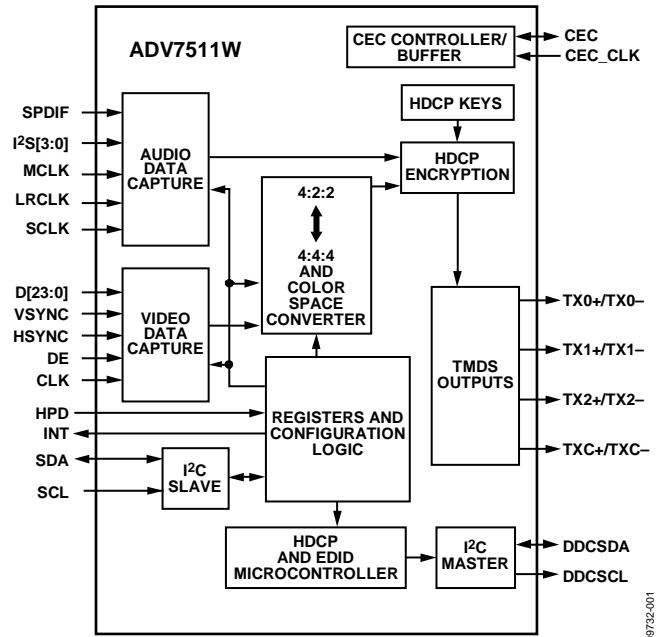


Figure 1.

GENERAL DESCRIPTION

The ADV7511W is a 165 MHz High-Definition Multimedia Interface (HDMI®) transmitter, which is ideal for automotive entertainment products including DVD players/recorders, digital set-top boxes, A/V receivers, gaming consoles, and PCs.

The digital video interface contains an HDMI v.1.4a/DVI v.1.0-compatible transmitter and supports all HDTV formats. The ADV7511W supports HDMI v.1.4a-specific features (3D video and extended colorimetry) in addition to x.v.Color™, high bit rate audio, and programmable AVI InfoFrames. Internal HDCP keys allow the secure transmission of protected content as specified by the HDCP v.1.3 protocol.

The ADV7511W supports both SPDIF and 8-channel I²S. Its high fidelity 8-channel I²S can transmit either stereo or 7.1 surround audio up to 768 kHz. The SPDIF can carry compressed audio including Dolby® Digital, DTS®, and THX®. Fabricated in an advanced CMOS process, the ADV7511W is provided in a 64-lead LQFP surface-mount plastic package with exposed paddle and is specified over the -40°C to +105°C temperature range.

Rev. 0

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REVISION HISTORY

5/11—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL SPECIFICATIONS

Table 1.

| Parameter | Test Conditions/ Comments | Temp | Test Level ¹ | Min | Typ | Max | Unit |
|---|---------------------------------------|------|----------------------------|------|------|------|-----------------|
| DIGITAL INPUTS | | | | | | | |
| Data Inputs—Video and Audio, CEC_CLK | | | | | | | |
| Input Voltage, High (V_{IH}) | | Full | VI | 1.35 | | 3.5 | V |
| Input Voltage, Low (V_{IL}) | | Full | VI | -0.3 | | +0.7 | V |
| Input Capacitance | | 25°C | VIII | | 1.0 | 1.5 | pF |
| I ² C Lines (DDCSDA, DDCSCL, SDA, SCL) | | | | | | | |
| Input Voltage, High (V_{IH}) | | Full | VI | 1.19 | | 5.5 | V |
| Input Voltage, Low (V_{IL}) | | Full | VI | -0.3 | | +0.8 | V |
| CEC | | | | | | | |
| Input Voltage, High (V_{IH}) | | Full | VI | 2.0 | | 5.5 | V |
| Input Voltage, Low (V_{IL}) | | Full | VI | -0.3 | | +0.8 | V |
| Output Voltage, High (V_{OH}) | | Full | VI | 2.5 | | 3.63 | V |
| Output Voltage, Low (V_{OL}) | | Full | VI | -0.3 | | +0.6 | V |
| HPD | | | | | | | |
| Input Voltage, High (V_{IH}) | | Full | VI | 1.3 | | 5.5 | V |
| Input Voltage, Low (V_{IL}) | | Full | VI | -0.3 | | +0.8 | V |
| THERMAL CHARACTERISTICS | | | | | | | |
| Thermal Resistance | | | | | | | |
| θ_{JC} Junction-to-Case | | Full | V | | 20 | | °C/W |
| θ_{JA} Junction-to-Ambient | | Full | V | | 43 | | °C/W |
| Ambient Temperature | | Full | V | -40 | +25 | +105 | °C |
| DC SPECIFICATIONS | | | | | | | |
| Input Leakage Current (I_{IL}) | | 25°C | VI | -1 | | +1 | μA |
| POWER SUPPLY | | | | | | | |
| 1.8 V Supply Voltage (DVDD, AVDD, PVDD, BGVDD) | | Full | IV | 1.71 | 1.8 | 1.90 | V |
| 3.3 V Supply Voltage (DVDD_3V) | | Full | | 3.15 | 3.3 | 3.45 | V |
| Power-Down Current | | 25°C | | | | 100 | μA |
| Transmitter Total Power (1.8 V Power = 200 mW and 3.3 V Power = 1 mW) | 1080p, 24 bit, typical random pattern | Full | VI | | 201 | | mW |
| AC SPECIFICATIONS | | | | | | | |
| TMDS Output Clock Frequency | | 25°C | IV | 20 | | 165 | MHz |
| TMDS Output Clock Duty Cycle | | 25°C | IV | 48 | | 52 | % |
| Input Video Clock Frequency | | Full | | | | 165 | MHz |
| Input Video Data Setup Time (t_{VSU}) ² | | Full | IV | 1.8 | | | ns |
| Input Video Data Hold Time (t_{VHD}) ² | | Full | IV | 1.3 | | | ns |
| TMDS Differential Swing | | 25°C | VII | 900 | 1100 | 1200 | mV |
| Differential Output Timing | | | | | | | |
| Low-to-High Transition Time | | 25°C | VII | 75 | 95 | | ps |
| High-to-Low Transition Time | | 25°C | VII | 75 | 95 | | ps |
| VSYNC and HSYNC Delay | | | | | | | |
| From DE Falling Edge | | 25°C | IV | | 1 | | UI ³ |
| To DE Rising Edge | | 25°C | IV | | 1 | | UI ³ |

ADV7511W

| Parameter | Test Conditions/ Comments | Temp | Test Level ¹ | Min | Typ | Max | Unit |
|---|------------------------------|------|-------------------------|-----|-----------------|-----|------|
| AUDIO AC TIMING | | | | | | | |
| SCLK Duty Cycle | | | | | | | |
| When N/2 Is an Even Number | | Full | IV | 40 | 50 | 60 | % |
| When N/2 Is an Odd Number | | Full | IV | 49 | 50 | 51 | % |
| I ² S[3:0], SPDIF Setup Time (t _{ASU}) | | Full | IV | 2 | | | ns |
| I ² S[3:0], SPDIF Hold Time (t _{AHLD}) | | Full | IV | 2 | | | ns |
| LRCLK Setup Time (t _{ASU}) | | Full | IV | 2 | | | ns |
| LRCLK Hold Time (t _{AHLD}) | | Full | IV | 2 | | | ns |
| CEC | | | | | | | |
| CEC_CLK Frequency | | Full | VIII | 3 | 12 ⁴ | 100 | MHz |
| CEC_CLK Accuracy | | Full | VIII | -2 | | +2 | % |
| I ² C INTERFACE | | | | | | | |
| SCL Clock Frequency | | Full | | | | 400 | kHz |
| SDA Setup Time (t _{DSU}) | | Full | | 100 | | | ns |
| SDA Hold Time (t _{DHO}) | | Full | | 100 | | | ns |
| Setup for Start (t _{STASU}) | | Full | | 0.6 | | | μs |
| Hold Time for Start (t _{STAH}) | | Full | | 0.6 | | | μs |
| Setup for Stop (t _{STOSU}) | | Full | | 0.6 | | | μs |

¹ See the Explanation of Test Levels section.

² This is measured at 0.9 V. The relationship between clock and data is programmable in 400 ps steps.

³ UI is the unit interval.

⁴ 12 MHz crystal oscillator for default register settings.

ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
|---|-------------------|
| Digital Inputs (SDA, SCL, DDCSDA, DDCSCL, HPD, PD, CEC) | -0.3 V to +5.5 V |
| Audio/Video Digital Inputs (MCLK, SPDIF, I2S[3:0], SCLK, HSYNC, DE, VSYNC, CEC_CLK) | -0.3 V to +3.63 V |
| Digital Output Current | 20 mA |
| Operating Temperature Range | -40°C to +105°C |
| Storage Temperature Range | -65°C to +150°C |
| Maximum Junction Temperature | 150°C |
| Maximum Case Temperature | 150°C |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

EXPLANATION OF TEST LEVELS

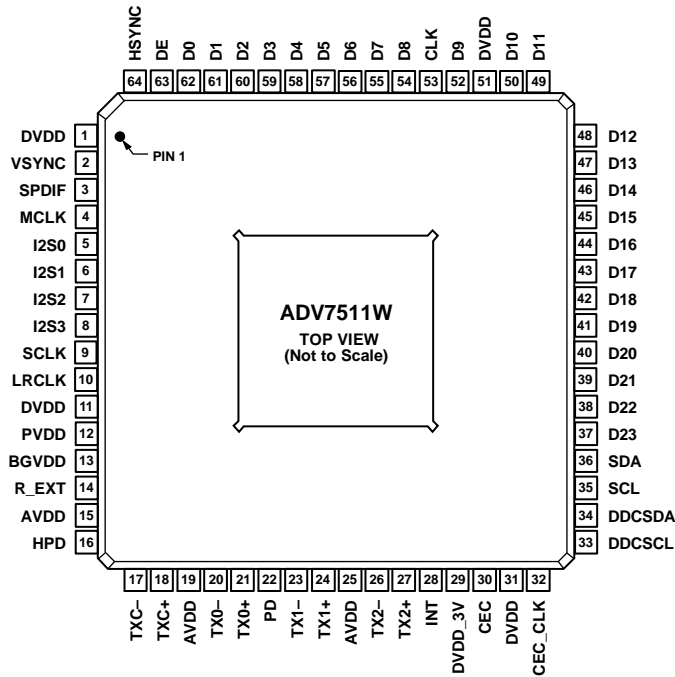
- I. 100% production tested.
- II. 100% production tested at 25°C and sample tested at specified temperatures.
- III. Sample tested only.
- IV. Parameter is guaranteed by design and characterization testing.
- V. Parameter is a typical value only.
- VI. 100% production tested at 25°C; guaranteed by design and characterization testing.
- VII. Limits defined by HDMI specification; guaranteed by design and characterization testing.
- VIII. Parameter is guaranteed by design.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES
1. THE LQFP HAS AN EXPOSED PAD THAT SHOULD BE CONNECTED TO GROUND.

Figure 2. Pin Configuration

Table 3. Pin Function Descriptions

| Pin No. | Mnemonic | Type | Description |
|---------------|------------|---------------------|---|
| 1, 11, 31, 51 | DVDD | Power | 1.8 V Power Supply. These pins should be filtered and as quiet as possible. |
| 2 | VSYNC | Input | Vertical Sync Input. |
| 3 | SPDIF | Input | SPDIF (Sony/Philips Digital Interface) Audio Input. |
| 4 | MCLK | Input | Audio Reference Clock Input. |
| 5 | I2S0 | Input | I ² S Channel 0 Audio Data Input. |
| 6 | I2S1 | Input | I ² S Channel 1 Audio Data Input. |
| 7 | I2S2 | Input | I ² S Channel 2 Audio Data Input. |
| 8 | I2S3 | Input | I ² S Channel 3 Audio Data Input. |
| 9 | SCLK | Input | I ² S Audio Clock Input. |
| 10 | LRCLK | Input | Left/Right Channel Signal Input. |
| 12 | PVDD | Power | 1.8 V PLL Power Supply. |
| 13 | BGVDD | Power | Band Gap Power Supply. |
| 14 | R_EXT | Input | This pin sets the internal reference currents. |
| 15, 19, 25 | AVDD | Power | 1.8 V Power Supply for TMDS Outputs. |
| 16 | HPD | Input | Hot Plug™ Detect Signal Input. |
| 17, 18 | TXC-, TXC+ | Differential output | Differential TMDS Clock Output. |
| 20, 21 | TX0-, TX0+ | Differential output | Differential TMDS Output Channel 0. |
| 22 | PD | Input | Power-Down Control and I ² C Address Selection. |
| 23, 24 | TX1-, TX1+ | Differential output | Differential TMDS Output Channel 1. |
| 26, 27 | TX2-, TX2+ | Differential output | Differential TMDS Output Channel 2. |
| 28 | INT | Output | Interrupt Signal Output. |
| 29 | DVDD_3V | Power | 3.3 V Power Supply. |

| Pin No. | Mnemonic | Type | Description |
|------------------------|----------|--------------|---|
| 30 | CEC | Input/output | CEC Data Signal. |
| 32 | CEC_CLK | Input | CEC clock is an oscillator from 3 MHz to 100 MHz. |
| 33 | DDCSCL | Control | Serial Port Data Clock to Sink. |
| 34 | DDCSDA | Control | Serial Port Data I/O to Sink. |
| 35 | SCL | Control | Serial Port Data Clock Input. |
| 36 | SDA | Control | Serial Port Data I/O. |
| 37 to 50, 52, 54 to 62 | D[23:0] | Input | Video Data Input |
| 53 | CLK | Input | Video Input Clock. |
| 63 | DE | Input | Data Enable Signal Input for Digital Video. |
| 64 | HSYNC | Input | Horizontal Sync Input. |
| | EPAD | Power | The LQFP has an exposed pad that should be connected to ground. |

APPLICATIONS INFORMATION

DESIGN RESOURCES

Evaluation kits, reference design schematics, hardware and software guides, and other support documentation are available from Analog Devices, Inc., [Engineer Zone](#).

Other references include the following:

- *EIA/CEA-861D*, a technical specifications document, describes audio and video InfoFrames, as well as the E-EDID structure for HDMI. It is available from the Consumer Electronics Association (CEA).
- *High-Definition Multimedia Interface Specification Version 1.4a*, a defining document for HDMI v.1.4a, and the *High-Definition Multimedia Interface Compliance Test Specification Version 1.4a* are available from HDMI Licensing, LLC.
- *High-Bandwidth Digital Content Protection System Revision 1.3*, the defining technical specifications document for the HDCP v.1.3, is available from Digital Content Protection, LLC.

OUTLINE DIMENSIONS

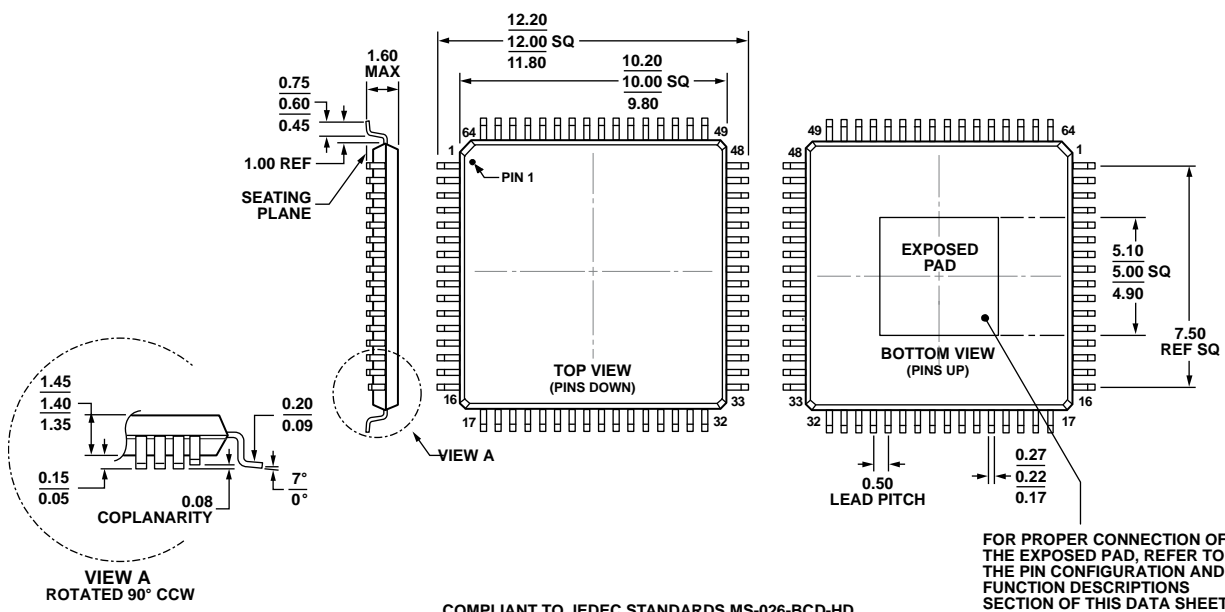


Figure 3. 64-Lead Low Profile Quad Flat Package [LQFP_EP] (SW-64-2)
Dimensions shown in millimeters

03-16-2010-A

ORDERING GUIDE

| Model ^{1, 2} | Temperature Range | Package Description | Package Option |
|-----------------------|-------------------|---|----------------|
| ADV7511WBSWZ | -40°C to +105°C | 64-Lead Low Profile Quad Flat Package with Exposed Pad [LQFP_EP] | SW-64-2 |
| ADV7511WBSWZ-RL | -40°C to +105°C | 64-Lead Low Profile Quad Flat Package with Exposed Pad [LQFP_EP], Tape and Reel | SW-64-2 |
| EVAL-ADV7511W-AKZ | | Evaluation Kit | |

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADV7511W models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

ADV7511W

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I²C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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